TBF-2012-245-R1 THIN FILM BAND PASS FILTER

1. Feature:

- 1. 2.45GHz Thin Film Band Pass Filter
- 2. For ISM Band applications like Wireless LAN & Bluetooth.
- 3. Lead Free

2. Part Number

TBF
$$2012 - 245 - R1 - XX$$

(1) (2) (3) (4) (5)

Where

- (1) TBF: Thin Film Band Pass Filter
- (2) Size: $4 \text{ digits of number } --2012 = 2.0 \times 1.25 \text{ mm}$
- (3) Center Frequency:

245 = 2.45 GHz (4) Type

Refer to Table 3-1

(5) XX

Internal Code

3. Ratings

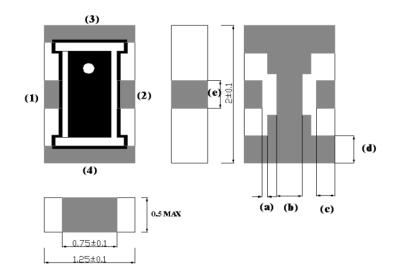
3-1 Specifications

Part Number	TBF-2012-245-R1
Nominal Characteristics Impedance	50 Ω
Nominal Center Frequency	2450MHz
Bandwidth	2400 ~ 2500MHz
Insertion Loss	1.5 dB Max. at +25 deg. C
	1.8 dB max. at -40 ~ +85 deg. C
Ripple in BW	0.5dB max.
Attenuation	30.0dB min. at 880~960MHz
	25.0dB min. at 1710~1910MHz
	30.0dB min. at 4800 ~ 5000MHz
	30.0dB min. at 7200 ~ 7500MHz (Option)
VSWR in BW	2.0 Max.
Power Capacity	500mW Max.

- 3-2 Operation Temperature: -40° C to $+85^{\circ}$ C
- 3-3 Storage Temperature: $+15^{\circ}$ C to $+35^{\circ}$ C

UNLESS OTHERWISE SPECIFIED	RELEASED BY:	Steven-Tseng	彭坤科技	股份有限公司	1
TOLERANCES ON :	DESIGNED BY	: Steven-Tseng			•
$\begin{array}{ccc} X & = \pm \\ X.X & = \pm \end{array}$	CHECKED BY	: Steven-Tseng	CYNIE	EC CO., LTD.	
$X.XX = \pm$	APPROVED BY	: Wang-Kevin	THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF CYNTEC AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE		
ANGLES ± HOLE DIA. ±	SCALE : X	UNIT : X		ARATUS OR DEVICES WITHOUT PERI	
TITLE: The Engineering Spec. for TBF-2012-245-R1 Band Pass Filter		DOCUMENT		PAGE REV.	
		NO.		A1	

4. Outline Dimension



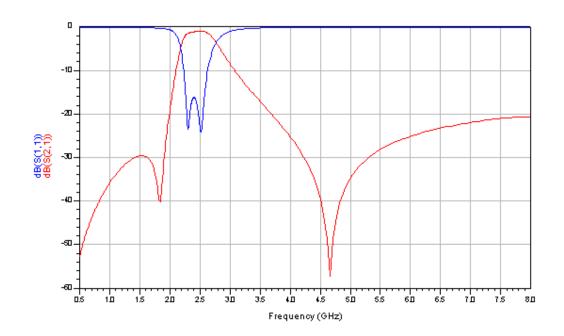
Code	Dimension
a	0.075 <u>+</u> 0.02
b	0.45 ± 0.1
С	0.25 ± 0.1
d	0.4 <u>+</u> 0.1
e	0.4 <u>+</u> 0.1

Unit: mm

Terminal Configuration:

Terminal No.	Terminal Name
(1)	Input
(2)	Output
(3)	GND
(4)	GND

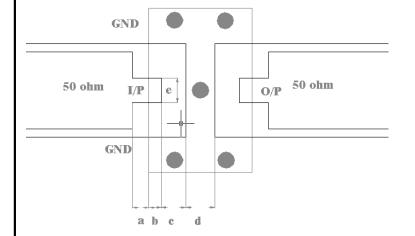
5. Electrical Performance



TITLE: The Engineering Spec. for TBF-2012-245-R1 Band Pass Filter

DOCUMENT NO. PAGE REV.

6. Recommended Land Pattern



a	0.2 mm
b	0.15 mm
c	0.3 mm
d	0.35 mm
e	0.3 mm

乾坤科技股份有限公司 CYNTEC CO., LTD. UNLESS OTHERWISE SPECIFIED RELEASED BY: Steven-Tseng TOLERANCES ON: DESIGNED BY : Steven-Tseng = ± CHECKED BY: Steven-Tseng X.X = ± THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF CYNTEC CO., LTD. AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION APPROVED BY: Wang-Kevin $X.XX = \pm$ ANGLES \pm HOLE DIA. \pm SCALE : X UNIT: X PAGE **DOCUMENT** TITLE: The Engineering Spec. for TBF-2012-245-R1 Band Pass Filter NO. A1

7. Reliability Test

7.1 Electrical

ITEM	Specification and Requirement	Test Method
Temperature Characteristics	Satisfy electrical characteristics	Solder the sample on PCB.
		Exposure at each temperature,
		-40°C , -20°C , 0°C , $+25^{\circ}\text{C}$, $+50^{\circ}\text{C}$,
		+85°C for 30minutes

7.2 Mechanical

ITEM	Specification and Requirement	Test Method
Solderability	The Surface of terminal immersed shall	Solder bath:
	be minimum of 95% covered with a new	
	coating of solder	\pm 5 °C molten solder bath for 2 \pm
		0.5 seconds
Resistance to solder Heat	Satisfy electrical characteristics without	A. Pre-heat : 100 ~ 110 °C for 30
	distinct deformation in appearance	seconds
		B. Immersed at solder bath of 270
		$\pm 5^{\circ}$ C for 20 ± 1 seconds
Vibration	Satisfy electrical characteristics without	
	Mechanical damage such as break	186m/s ² (19G) acceleration 1.5mm
		amplitude for 2 hours in each of
		three (X, Y, Z) axis (total 6 hours).
Shock	Satisfy electrical characteristics without	
	mechanical damaged such as break	(2) Duration of pulse : 11ms
		(3) 3 times in each positive and
		negative direction of 3 mutual
Danding Test	Catiofy alastrical abarratoristics without	perpendicular directions.
Bending Test	Satisfy electrical characteristics without mechanical damage such as break	seconds ± 1
Solvent Resistant	Marking should be legible without	
Sorvent Resistant		Isopropyl alcohol.
	appearance	(2) Immersed in solvent at room
		temperature for 90 seconds
Drop Test	Satisfy electrical characteristics without	
210P 1000	mechanical damage	1m to concrete ground for 10 times
_		

UNLESS OTHERWISE SPECIFIED	RELEASED BY: Steven-Tseng DESIGNED BY: Steven-Tseng CHECKED BY: Steven-Tseng		乾坤科技股份有限公司		
TOLERANCES ON:			- CVNTEC CO ITD		•
$\begin{array}{ccc} X & = \pm \\ X.X & = \pm \end{array}$					
$X.XX = \pm$	APPROVED BY : Wang-Kevin			IONS ARE THE PROPERTY OF CYNT D OR USED AS THE BASIS FOR THE	EC CO., LTD.
ANGLES ± HOLE DIA. ±	SCALE : X	UNIT: X		ARATUS OR DEVICES WITHOUT PERI	MISSION
TITLE AT DE LEGISLA OF THE COLOR OF THE COLO		DOCUMENT		PAGE REV.	
IIILE . The Engineering Spec. 1	TITLE: The Engineering Spec. for TBF-2012-245-R1 Band Pass Filter		NO.		A1

7.3 Load Life

ITEM	Specification and Requirement	Test Method
Rapid change of temperature	Satisfy Electrical Characteristics.	Perform 5 cycles as follows:
	Without distinct damage.	-55°C for 30minutes → room
		temperature for 3 minutes→
		$+125^{\circ}$ C for 30minutes \rightarrow room
		temperature for 3 minutes.
		(Dwell time : 5 to 8 minutes)
Humidity Resistance Test	Satisfy Electrical Characteristics.	Precondition at +25°C for 1hour.
	Without distinct damage.	Let stand at temperature $+40 \pm 3$
		°C, 90~95% relative humidity for
		1,000 hours before taking final
		measurements.
Low Temperature Store	Satisfy Electrical Characteristics.	Solder the sample on PCB.
	Without distinct damage.	Exposure at $-55 \pm 3^{\circ}$ C for 1,000
		hours.
		1~2 hours exposure at room
		temperature and humidity, prior to
		measurement.
High Temperature Store	Satisfy Electrical Characteristics.	Solder the sample on PCB.
	Without distinct damage.	Exposure at $+85 \pm 3^{\circ}$ C for 1,000
		hours.
		1~2 hours exposure at room
		temperature and humidity, prior to
		measurement.
Load Life	Satisfy Electrical Characteristics.	Apply 16 Volt voltage at 70±2℃
	Without distinct damage.	ambient

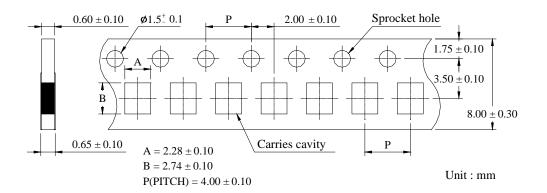
UNLESS OTHERWISE SPECIFIED TOLERANCES ON: X = ± X.X = ±	RELEASED BY : S DESIGNED BY : CHECKED BY	Steven-Tseng		股份有限公司 C CO., LTD.	J
$X.XX = \pm$ ANGLES \pm HOLE DIA. \pm	APPROVED BY SCALE : X	: Wang-Kevin UNIT : X	AND SHALL NOT BE REPRODUCE	IONS ARE THE PROPERTY OF CYNTI D OR USED AS THE BASIS FOR THE ARATUS OR DEVICES WITHOUT PERI	·
TITLE: The Engineering Spec. f	or TBF-2012-245-R	1 Band Pass Filter	DOCUMENT NO.		PAGE REV.

8. Packaging

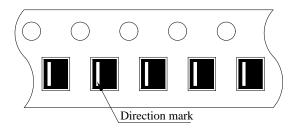
8-1 Material: Paper Carrier Tape

8-2 Dimensions

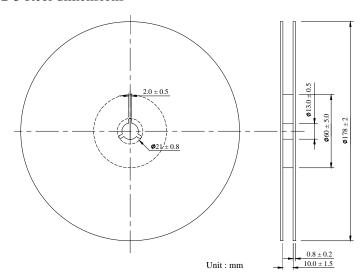
8-2-1 Tape packaging dimensions



8-2-2 Setting Direction



8-2-3 Reel dimensions

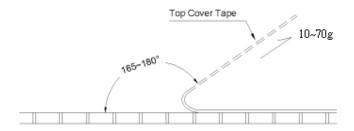


UNLESS OTHERWISE SPECIFIED TOLERANCES ON: X = ± X.X = ±	RELEASED BY : S DESIGNED BY : CHECKED BY	Steven-Tseng	乾坤科技 CYNTE	股份有限公司 C CO., LTD.)
$X.XX = \pm$ ANGLES \pm HOLE DIA. \pm	APPROVED BY SCALE : X	: Wang-Kevin UNIT : X	AND SHALL NOT BE REPRODUCE	IONS ARE THE PROPERTY OF CYNTI D OR USED AS THE BASIS FOR THE ARATUS OR DEVICES WITHOUT PERI	,
TITLE: The Engineering Spec. 1	for TBF-2012-245-R	21 Band Pass Filter	DOCUMENT NO.		PAGE REV.

8-3 Peel force of top cover tape

The peel speed shall be about 300 mm/minute

The peel force of top cover tape shall be between 10 to 70g



8-4 Numbers of taping

4,000 pieces/reel

8-5 Label marking

The following items shall be marked on the production and shipping Label on the reel.

8-5-1 Production Label

- (1) Part No.
- (2) Description
- (3) Quantity
- (4) Taping No.

8-5-2 Shipping Label

- (1) *Customer's name
- (2) *Customer's part No.
- (3) Manufacturer's part No.
- (4) Manufacturer's name
- (5) Manufacturer's country

*Note: Item (1) and (2) are listed by request

UNLESS OTHERWISE SPECIFIED TOLERANCES ON:	—		乾坤科技	股份有限公司]
$X = \pm$	DESIGNED BY	: Steven-Tseng		C CO., LTD.	•
$X = \pm $	CHECKED BY	: Steven-Tseng	CTIVIE	C CO., LID.	
$X.XX = \pm$	APPROVED BY	: Wang-Kevin		IONS ARE THE PROPERTY OF CYNT D OR USED AS THE BASIS FOR THE	EC CO., LTD.
ANGLES ± HOLE DIA. ±	SCALE : X	UNIT : X		ARATUS OR DEVICES WITHOUT PER	MISSION
			DOCUMENT		PAGE REV.
TITLE: The Engineering Spec.	tor TBF-2012-245-R	CI Band Pass Filter	NO.		A1